High-speed switching diodes Rev. 8 — 18 March 2015

Product data sheet

1. **Product profile**

1.1 General description

High-speed switching diodes, encapsulated in small Surface-Mounted Device (SMD) plastic packages.

Table 1. **Product overview**

Type number	Package			Package	Configuration
	Nexperia	JEITA	JEDEC	configuration	
BAV70	SOT23	-	TO-236AB	small	dual common cathode
BAV70M	SOT883	SC-101	-	leadless ultra small	dual common cathode
BAV70S	SOT363	SC-88	-	very small	quadruple common cathode/common cathode
BAV70T	SOT416	SC-75	-	ultra small	dual common cathode
BAV70W	SOT323	SC-70	-	very small	dual common cathode

1.2 Features and benefits

- High switching speed: $t_{rr} \le 4$ ns
- Low leakage current
- Small SMD plastic packages

1.3 Applications

- High-speed switching
- General-purpose switching

1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per diode		·					
I _R	reverse current	V _R = 80 V		-	-	0.5	μA
V _R	reverse voltage			-	-	100	V
t _{rr}	reverse recovery time		[1]	-	-	4	ns

[1] When switched from I_F = 10 mA to I_R = 10 mA; R_L = 100 Ω ; measured at I_R = 1 mA.

- Low capacitance: $C_d \le 1.5 \text{ pF}$
- Reverse voltage: $V_R \le 100 \text{ V}$
- AEC-Q101 qualified



High-speed switching diodes

2. Pinning information

Table 3. F	Pinning		
Pin	Description	Simplified outline	Symbol
BAV70; BAV	/70T; BAV70W		1
1	anode (diode 1)		
2	anode (diode 2)	3	3
3	common cathode	12	1 2 006aab034
BAV70M			
1	anode (diode 1)		3
2	anode (diode 2)		
3	common cathode	2 Transparent top view	1 2 006aab034
BAV70S			
1	anode (diode 1)		
2	anode (diode 2)		6 5 4
3	common cathode (diode 3 and diode 4)	0	
4	anode (diode 3)	1 2 3	
5	anode (diode 4)		1 2 3
6	common cathode (diode 1 and diode 2)		006aab104

3. Ordering information

Table 4. Ordering information

Type number	Package	Package				
Name Descri		Description	Version			
BAV70	-	plastic surface-mounted package; 3 leads	SOT23			
BAV70M	SC-101	leadless ultra small plastic package; 3 solder lands; body $1.0 \times 0.6 \times 0.5$ mm	SOT883			
BAV70S	SC-88	plastic surface-mounted package; 6 leads	SOT363			
BAV70T	SC-75	plastic surface-mounted package; 3 leads	SOT416			
BAV70W	SC-70	plastic surface-mounted package; 3 leads	SOT323			

BAV70_SER Product data sheet

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4. Marking

Table 5. Marking codes					
Type number	Marking code ^[1]				
BAV70	A4*				
BAV70M	S4				
BAV70S	A4*				
BAV70T	A4				
BAV70W	A4*				

[1] * = -: made in Hong Kong

* = p: made in Hong Kong

* = t: made in Malaysia

* = W: made in China

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per diode					
V _{RRM}	repetitive peak reverse voltage		-	100	V
V _R	reverse voltage		-	100	V
l _F	forward current				
	BAV70	$T_{amb} \le 25 \ ^{\circ}C$	-	215	mA
	BAV70M	T _s = 90 °C	-	150	mA
	BAV70S	T _s = 60 °C	-	250	mA
	BAV70T	T _s = 90 °C	-	150	mA
	BAV70W	$T_{amb} \le 25 \ ^{\circ}C$	-	175	mA
I _{FRM}	repetitive peak forward current				
	BAV70		-	450	mA
	BAV70M		-	500	mA
	BAV70S		-	450	mA
	BAV70T		-	500	mA
	BAV70W		-	500	mA
I _{FSM}	non-repetitive peak forward	square wave	L		
	current	t _p = 1 μs	-	4	А
		t _p = 1 ms	-	1	А
		t _p = 1 s	-	0.5	А

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Symbol	Parameter	Conditions	Min	Мах	Unit
P _{tot}	total power dissipation	[2]			
	BAV70	$T_{amb} \le 25 \ ^{\circ}C$	-	250	mW
	BAV70M	$T_{amb} \le 25 \ ^{\circ}C$ [3]	-	250	mW
BAV	BAV70S	$T_s = 60 \ ^{\circ}C$	-	350	mW
	BAV70T	T _s = 90 °C	-	170	mW
BAV70W		$T_{amb} \le 25 \ ^{\circ}C$	-	200	mW
Per device)				
I _F forward curren	forward current				
	BAV70	$T_{amb} \le 25 \ ^{\circ}C$	-	125	mA
	BAV70M	T _s = 90 °C	-	75	mA
	BAV70S	$T_s = 60 \ ^\circ C$	-	100	mA
	BAV70T	T _s = 90 °C	-	75	mA
	BAV70W	$T_{amb} \le 25 \ ^{\circ}C$	-	100	mA
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

Table 6. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

[1] $T_i = 25 \circ C$ prior to surge.

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[3] Reflow soldering is the only recommended soldering method.

6. Thermal characteristics

Table 7.Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per diode							
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1]				
	BAV70			-	-	500	K/W
	BAV70M		[2]	-	-	500	K/W
	BAV70W			-	-	625	K/W
R _{th(j-t)}	thermal resistance from junction to tie-point						
	BAV70			-	-	360	K/W
	BAV70W			-	-	300	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point						
	BAV70S			-	-	255	K/W
	BAV70T			-	-	350	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

BAV70_SER

7. Characteristics

Table 8.

T _{amb} = 25 °C unless otherwise specified.						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode						
V _F	forward voltage	<u>[1]</u>				
		I _F = 1 mA	-	-	715	mV
		I _F = 10 mA	-	-	855	mV
		I _F = 50 mA	-	-	1	V
		I _F = 150 mA	-	-	1.25	V
I _R	reverse current	V _R = 25 V	-	-	30	nA
		V _R = 80 V	-	-	0.5	μA
		V _R = 25 V; T _j = 150 °C	-	-	30	μA
		$V_R = 80 V; T_j = 150 °C$	-	-	100	μA
C _d	diode capacitance	V _R = 0 V; f = 1 MHz	-	-	1.5	pF
t _{rr}	reverse recovery time	[2]	-	-	4	ns
V _{FR}	forward recovery voltage	[3]	-	-	1.75	V

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[2] When switched from I_F = 10 mA to I_R = 10 mA; R_L = 100 Ω ; measured at I_R = 1 mA.

[3] When switched from $I_F = 10 \text{ mA}$; $t_r = 20 \text{ ns}$.

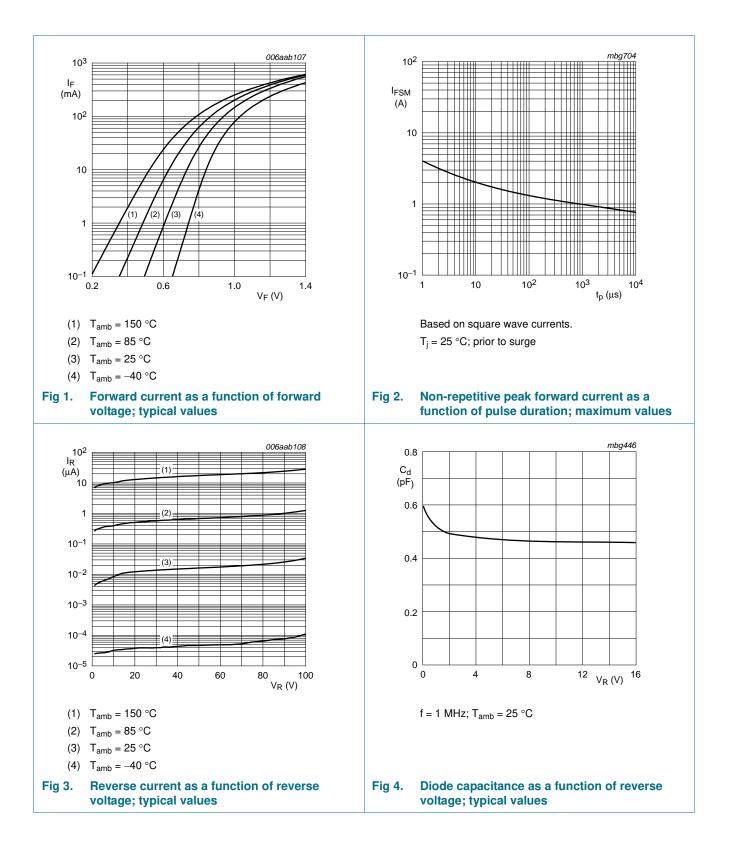
Characteristics

BAV70_SER

Nexperia

BAV70 series

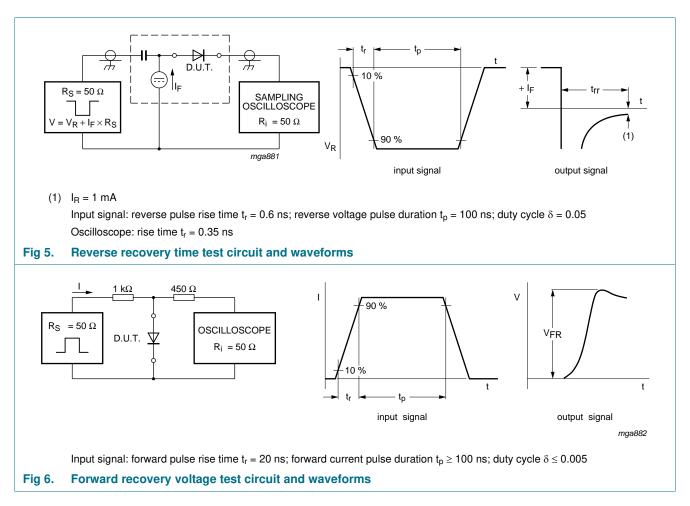
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8. Test information

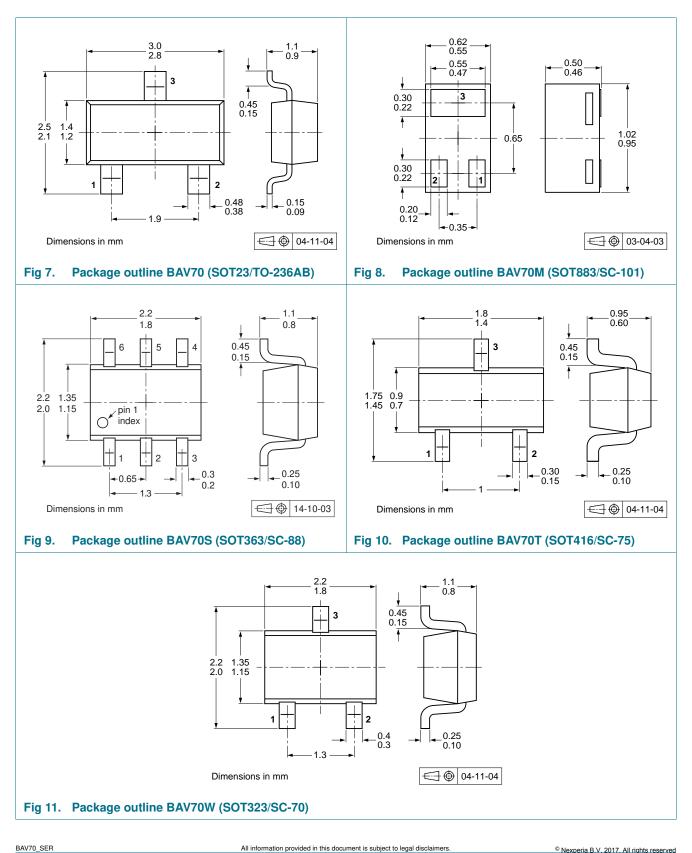


8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

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Package outline 9.



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10. Packing information

Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

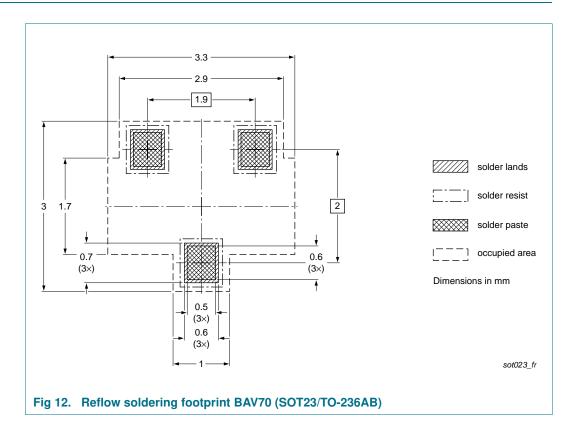
Type number	Package	Description	Packing quantity	
			3000	10000
BAV70	SOT23	4 mm pitch, 8 mm tape and reel	-215	-235
BAV70M	SOT883	2 mm pitch, 8 mm tape and reel		-315
BAV70S	SOT363	4 mm pitch, 8 mm tape and reel; T1 [2]	-115	-135
		4 mm pitch, 8 mm tape and reel; T2 [3]	-125	-165
BAV70T	SOT416	4 mm pitch, 8 mm tape and reel -115		-135
BAV70W	SOT323	4 mm pitch, 8 mm tape and reel	-115	-135

[1] For further information and the availability of packing methods, see <u>Section 14</u>.

[2] T1: normal taping

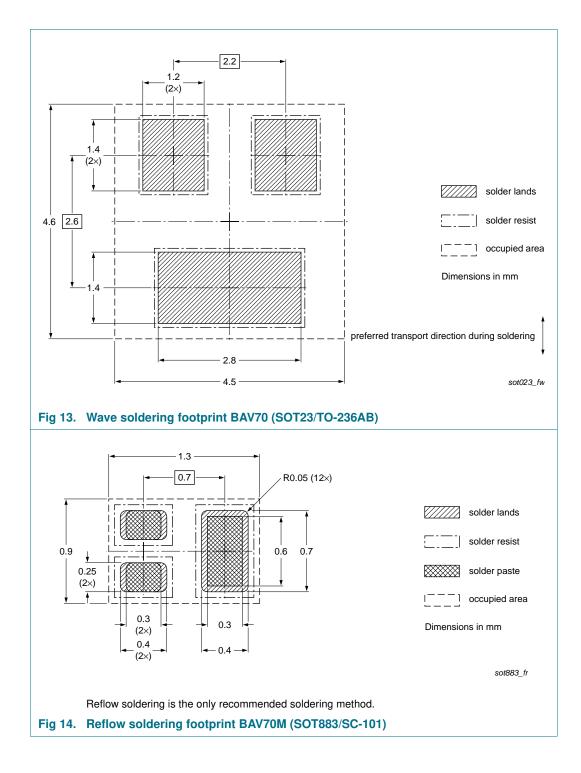
[3] T2: reverse taping

11. Soldering

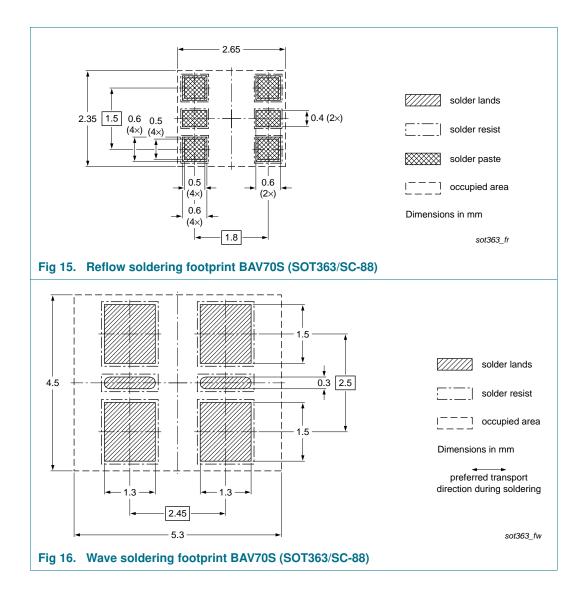


BAV70_SER

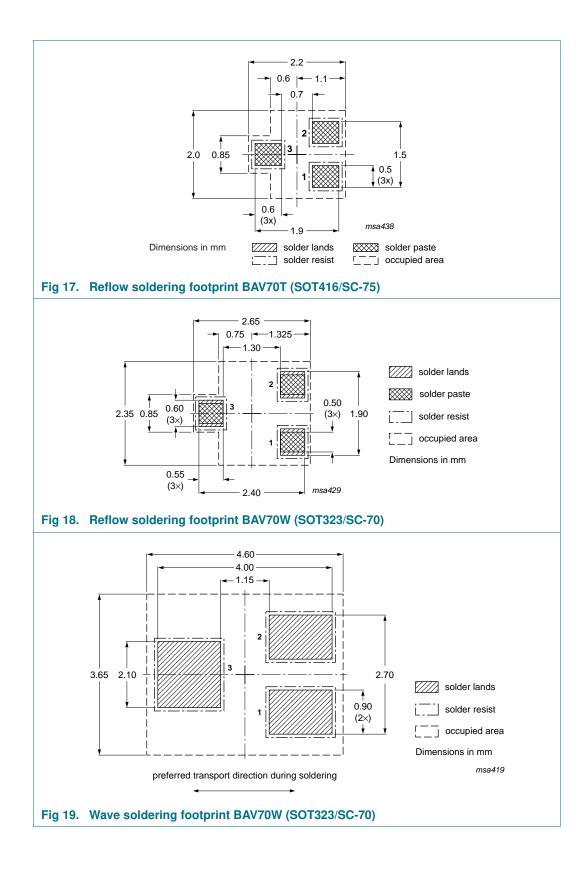
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12. Revision history

Table 10. Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
BAV70_SER v.8	20150318	Product data sheet	-	BAV70_SER_7
Modifications:		this data sheet has been rede NXP Semiconductors.	signed to comply wi	th the new identity
	 Legal texts have 	ave been adapted to the new c	ompany name wher	e appropriate.
BAV70_SER_7	20071127	Product data sheet	-	BAV70_6 BAV70S_2 BAV70T_3 BAV70W_6
BAV70_6	20020403	Product specification	-	BAV70_5
BAV70S_2	19971021	Product specification	-	BAV70S_1
BAV70T_3	20040204	Product specification	-	BAV70T_2
BAV70W_6	20020405	Product specification	-	BAV70W_5

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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